

### ABL45-24-80-D & ABL54-24-80-D

TX:1490nm/RX:1550nm SFP Single-Mode for 1.25G FC/GBE TX:1550nm/RX:1490nm SFP Single-Mode for 1.25G FC/GBE

BIDI SFP Transceiver RoHS 6 Compliant



#### Features

- Operating data rate up to 1.25Gbps
- Two types:
- TX:1490nm Transmitter/RX:1550nm Receiver
- TX:1550nm Transmitter/RX:1490nm Receiver
- Maximum link length of 80Km
- Single 3.3V Power supply and TTL Logic Interface
- BIDI LC Connector Interface
- Operating Case Temperature: -40 °C ~+85 °C
- Hot Pluggable
- Compliant with SFP+ MSA Specification
- Compliant with SFF-8472

### **Applications**

- Gigabit Ethernet Switches and Routers
- Fiber Channel Switch Infrastructure

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Other Optical Links

## Regulatory Compliance

Feature	Standard	Performance
Electrostatic Discharge	MIL-STD-883G	Class 1C (>1000 V)
(ESD) to the Electrical Pins	Method 3015.7	Class 1C (>1000 V)
Electrostatic Discharge	EN 55024:1998+A1+A2	
Electrostatic Discharge to the Enclosure	IEC-61000-4-2	Compliant with standards
to the Eliciosure	GR-1089-CORE	
	FCC Part 15 Class B	
Electromagnetic	EN55022:2006	Compliant with standards
Interference (EMI)	CISPR 22B :2006	Compliant with standards
	VCCI Class B	



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Immunity	EN 55024:1998+A1+A2 IEC 61000-4-3	Compliant with standards. 1KHz sine-wave, 80% AM, from 80MHz to 1GHz. No effect on transmitter/receiver performance is detectable between these limits.
Laser Eye Safety	FDA 21CFR 1040.10 and 1040.11 EN (IEC) 60825-1:2007 EN (IEC) 60825-2:2004+A1	CDRH compliant and Class I laser product.
Component Recognition	UL and CUL EN60950-1:2006	Compliant with standards
RoHS6	2002/95/EC 4.1&4.2 2005/747/EC 5&7&13	Compliant with standards <sup>note1</sup>

Note1: For update of the equipments and strict control of raw materials, 10Gtek has the ability to supply the customized products since Jan 1st, 2007, which meets the requirements of RoHS6 (Restrictions on use of certain Hazardous Substances) of European Union.

In light of item 5 in RoHS exemption list of RoHS Directive 2002/95/EC, Item 5: Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.

In light of item 13 in RoHS exemption list of RoHS Directive 2005/747/EC, Item 13: Lead and cadmium in optical and filter glass. The three exemptions are being concerned for 10Gtek's transceivers, because 10Gtek's transceivers use glass, which may contain Pb, for components such as lenses, isolators, and other electronic components.

### **Product Description**

The series Single-mode transceiver is SFP module for BIDI optical data communications such as Gigabit Ethernet 1000BASE-LX and Fiber Channel 1x SM-LC-L FC-PI. It is with the SFP 20-pin connector to allow hot plug capability.

The ABL45-24-80-D uses a 1490nm Distributed Feedback Laser (DFB), which is a Class 1 laser compliant according to International Safety Standard IEC 60825. The receiver section uses an integrated GaAs detector preamplifier (IDP) mounted in an optical header and a limiting post-amplifier IC, The ABL54-24-80-D uses a 1550nm Distributed Feedback Laser (DFB), which is a Class 1 laser compliant according to International Safety Standard IEC 60825. The receiver section uses an integrated GaAs detector preamplifier (IDP) mounted in an optical header and a limiting post-amplifier IC.

### Absolute Maximum Ratingsnote2

Parameter	Symbol	Min.	Max.	Unit
Storage Temperature	Ts	-40	+85	°C
Operating Case Temperature	T <sub>case</sub>	-40	+85	°C
Supply Voltage	Vcc	-0.5	3.6	V

Note2: Exceeding any one of these values may destroy the device permanently.

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## **Recommended Operating Conditions**

Parameter	Symbol	Min.	Typical	Max.	Unit
Operating Case Temperature	T <sub>A</sub>	-40		+85	°C
Power Supply Voltage	V <sub>CC</sub>	3.14	3.3	3.46	V
Power Supply Current	Icc			300	mA
Baud Rate			1.25		Gbps

## Performance Specifications - Electrical

Parameter	Symbol	Min.	Тур.	Max	Unit	Notes		
Transmitter								
LVPECL Inputs(Differential)	Vin	400		2000	mVpp	AC coupled inputs		
Input Impedance (Differential)	Zin	85	100	115	ohms	Rin > 100 kohms @ DC		
Tx_DISABLE Input Voltage - High		2		Vcc	V			
Tx_DISABLE Input Voltage - Low		0		0.8	V			
Tx_FAULT Output Voltage - High		2		Vcc+0.3	V	Io = 400μA; Host Vcc		
Tx_FAULT Output Voltage - Low		0		0.5	V	Io = -4.0mA		
		F	Receiver					
LVPECL Outputs (Differential)	Vout	700			mVpp	AC coupled outputs		
Output Impedance (Differential)	Zout	85	100	115	ohms			
Rx_LOS Output Voltage - High		2		Vcc+0.3	V	lo = 400μA; Host Vcc		
Rx_LOS Output Voltage - Low		0		0.8	V	Io = -4.0mA		
MOD_DEF ( 0:2 )	VoH	2.5			V	With Serial ID		
WOD_DEI ( 0.2 )	VoL	0		0.5	V	With Ochai ib		

### Optical and Electrical Characteristics

### (ABL45-24-80-D)

Parameter	Symbol	Min.	Typical	Max.	Unit
SMF			80		Km
Data Rate			1.25		Gbps

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	Tr	ansmitter				
Centre Wavelength		λc	1470	1490	1510	nm
Spectral Width (-	20dB)	Δλ			1	nm
Side Mode Suppress	sion Ratio	SMSR	30			dB
Average Output I	Power	P <sub>out, AVG</sub>	0		5	dBm
Extinction Ra	tio	ER	9			dB
Output Optical	Eye			IEEE 802.3	-2005 Comp	oliant
Transmitter and Disper	sion Penalty	TDP			3.9	dB
Average Power of OFF	Transmitter				-30	dBm
Relative Intensity	Noise	RIN			-128	dB/Hz
Input Differential Im	pedance	Z <sub>IN</sub>	90	100	110	Ω
TV D's state	Disable		2.0		Vcc+0.3	
TX Disable	Enable		0		0.8	V
TV Fault	Fault		2.0		V <sub>CC</sub> +0.3	\ /
TX Fault	Normal		0		0.8	V
TX Disable Asser	t Time	t_off			10	us
	F	Receiver				
Centre Wavele	ngth	λc	1520	1550	1580	nm
Sensitivitynote	e3	PIN			-24	dBm
Receiver Overl	oad	P <sub>MAX</sub>	-3			dBm
Output Differential In	npedance	Pin	90	100	110	Ω
LOS De-Asse	ert	LOS <sub>D</sub>			-24	dBm
LOS Assert		LOSA	-35			dBm
LOS	High		2.0		V <sub>CC</sub> +0.3	V
LUS	Low		0		0.8	V

Note3: Measured with worst ER, BER less than 1E-12 and PRBS  $2^7$ -1 at 1.25Gbps.

### (ABL54-24-80-D)

1					
Parameter	Symbol	Min.	Typical	Max.	Unit
SMF			80		Km
Data Rate			1.25		Gbps
Tra	nsmitter				
Centre Wavelength	λc	1530	1550	1570	nm
Spectral Width (-20dB)	Δλ			1	nm
Side Mode Suppression Ratio	SMSR	30			dB
Average Output Power	P <sub>out, AVG</sub>	0		5	dBm
Extinction Ratio	ER	9			dB
Output Optical Eye		IEEE 802.3-2005 Compliant			oliant
Transmitter and Dispersion Penalty	TDP			3.9	dB
Average Power of OFF Transmitter				-30	dBm
Relative Intensity Noise	RIN			-128	dB/Hz

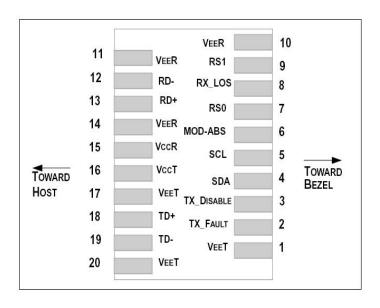


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Input Differential Impedance		Z <sub>IN</sub>	90	100	110	Ω
TV Disable	Disable		2.0		Vcc+0.3	V
TX Disable	Enable		0		0.8	V
TX Fault	Fault		2.0		V <sub>CC</sub> +0.3	V
1 A Fault	Normal		0		0.8	V
TX Disable Asser	t Time	t_off			10	us
Receiver						
Centre Wavele	Centre Wavelength		1460	1490	1520	nm
Sensitivity <sup>not</sup>	Sensitivity <sup>note3</sup>				-24	dBm
Receiver Overl	oad	P <sub>MAX</sub>	-3			dBm
Output Differential In	npedance	P <sub>IN</sub>	90	100	110	Ω
LOS De-Assert		LOS <sub>D</sub>			-24	dBm
LOS Assert		LOSA	-35			dBm
LOS	High		2.0		V <sub>CC</sub> +0.3	V
LOS	Low		0		0.8	V

## SFP Transceiver Electrical Pad Layout



### Pin Function Definitions

Pin Num.	Name	FUNCTION	Plug Seq.	Notes
1	VeeT	Transmitter Ground	1	Note8
2	TX Fault	Transmitter Fault Indication	3	Note4
3	TX Disable	Transmitter Disable	3	Note 6, Module disables on high or open



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4	SDA	Module Definition 2	3	Note6, Data line for Serial ID.
5	SCL	Module Definition 1	3	Note6, Clock line for Serial ID.
6	MOD_ABS	Module Definition 0	3	Note6
7	RS0	RX Rate Select (LVTTL).	3	This pin has an internal 30k pull down to ground. A signal on this pin will not affect module performance.
8	LOS	Loss of Signal	3	Note7
9	RS1	TX Rate Select (LVTTL).	1	This pin has an internal 30k pull down to ground. A signal on this pin will not affect module performance.
10	VeeR	Receiver Ground	1	Note8
11	VeeR	Receiver Ground	1	Note8
12	RD-	Inv. Received Data Out	3	Note9
13	RD+	Received Data Out	3	Note9
14	VeeR	Receiver Ground	1	Note8
15	VccR	Receiver Power	2	3.3 ± 5%, Note10
16	VccT	Transmitter Power	2	3.3 ± 5%, Note10
17	VeeT	Transmitter Ground	1	Note8
18	TD+	Transmit Data In	3	Note11
19	TD-	Inv. Transmit Data In	3	Note11
20	VeeT	Transmitter Ground	1	Note8

Note4: TX Fault is an open collector/drain output, which should be pulled up with a  $4.7K - 10K\Omega$  resistor on the host board. Pull up voltage between 2.0V and VccT, R+0.3V. When high, output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.

Note5: TX disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7 - 10 \text{ K}\Omega$  resistor. Its states are:

Low (0 - 0.8V): Transmitter on (>0.8, < 2.0V): Undefined

High (2.0 - 3.465V): Transmitter Disabled

Open: Transmitter Disabled

Note6: Modulation Absent, connected to VEET or VEER in the module.

Note7: LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a  $4.7K - 10K\Omega$  resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to<0.8V.

Note8: VeeR and VeeT may be internally connected within the SFP module.

Note9: RD-/+: These are the differential receiver outputs. They are AC coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 350 and 700 mV differential (175 –350 mV single ended) when properly terminated.



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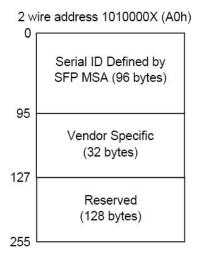
Note10: VccR and VccT are the receiver and transmitter power supplies. They are defined as 3.3V ±5% at the SFP connector pin. Maximum supply current is 300mA. Recommended host board power supply filtering is shown below. Inductors with DC resistance of less than 1 ohm should be used in order to maintain the required voltage at the SFP input pin with 3.3V supply voltage. When the recommended supply-filtering network is used, hot plugging of the SFP transceiver module will result in an inrush current of no more than 30mA greater than the steady state value. VccR and VccT may be internally connected within the SFP transceiver module.

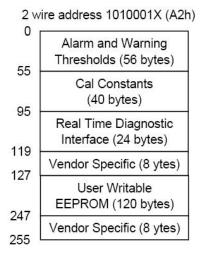
Note11: TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 150–1200 mV(75–600mV single-ended).

#### **EEPROM**

The serial interface uses the 2-wire serial CMOS EEPROM protocol defined for the ATMEL AT24C02/04 family of components. When the serial protocol is activated, the host generates the serial clock signal (SCL). The positive edge clocks data into those segments of the EEPROM that are not writing protected within the SFP transceiver. The negative edge clocks data from the SFP transceiver. The serial data signal (SDA) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially.

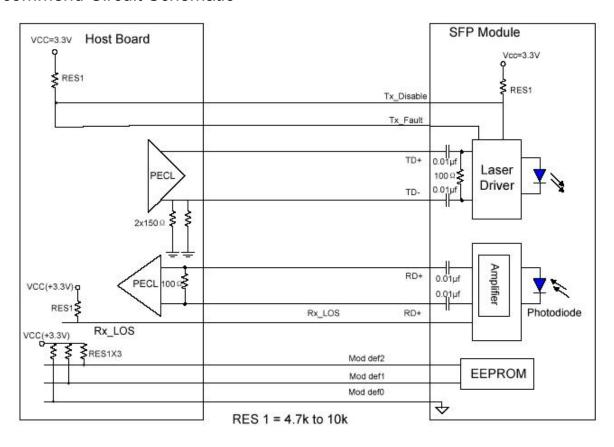
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Calibration and alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented. If the module is defined as external calibrated, the diagnostic data are raw A/D values and must be converted to real world units using calibration constants stored in EEPROM locations 56 – 95 at wire serial bus address A2h. The digital diagnostic memory map specific data field define as following .For detail EEPROM information, please refer to the related document of SFF 8472 Rev9.3.



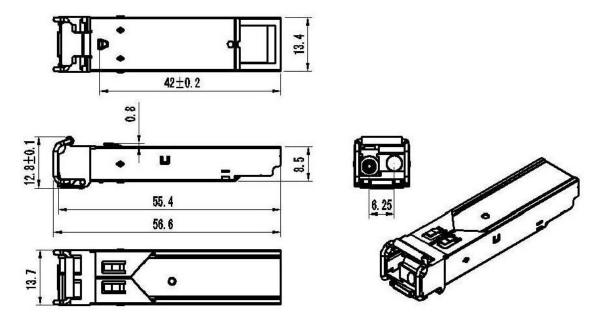




### **Recommend Circuit Schematic**



### **Mechanical Specifications**





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## **Revision History**

Revision	Initiated	Approved	content	Release Date
Ver1.0	Jacky	Nicky	Released	Dec/2011

## **Ordering information**

Part No.	Data Rate	Laser	Fibre Type	Temp.	Distance	Optical Interface	DDMI
ABL45-24-80-D	1.25Gbp s	1490nm DFB	SMF	-40~85℃	80Km	LC	YES
ABL54-24-80-D	1.25Gbp s	1550nm DFB	SMF	-40~85℃	80Km	LC	YES

#### **Further Information**

For further information, please contact <a href="mailto:info@10gtek.com">info@10gtek.com</a>

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